

2N6497

High Voltage NPN Silicon Power Transistors

These devices are designed for high voltage inverters, switching regulators and line-operated amplifier applications. Especially well suited for switching power supply applications.

Features

- High Collector–Emitter Sustaining Voltage –
 $V_{CEO(sus)} = 250 \text{ Vdc (Min)}$
- Excellent DC Current Gain –
 $h_{FE} = 10\text{--}75 @ I_C = 2.5 \text{ Adc}$
- Low Collector–Emitter Saturation Voltage @ $I_C = 2.5 \text{ Adc}$ –
 $V_{CE(sat)} = 1.0 \text{ Vdc (Max)}$
- Pb–Free Packages are Available*

MAXIMUM RATINGS (Note 1)

| Rating | Symbol | Value | Unit |
|---|----------------|-------------|--------------------------|
| Collector–Emitter Voltage | V_{CEO} | 250 | Vdc |
| Collector–Base Voltage | V_{CB} | 350 | Vdc |
| Emitter–Base Voltage | V_{EB} | 6.0 | Vdc |
| Collector Current – Continuous – Peak | I_C | 5.0 10 | Adc |
| Base Current | I_B | 2.0 | Adc |
| Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C | P_D | 80 0.64 | W W/ $^\circ\text{C}$ |
| Operating and Storage Junction Temperature Range | T_J, T_{stg} | –65 to +150 | $^\circ\text{C}$ |

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Max | Unit |
|--------------------------------------|-----------------|------|--------------------|
| Thermal Resistance, Junction–to–Case | $R_{\theta JC}$ | 1.56 | $^\circ\text{C/W}$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Indicates JEDEC Registered Data.

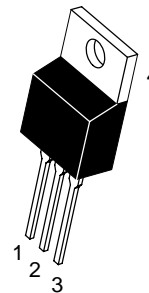


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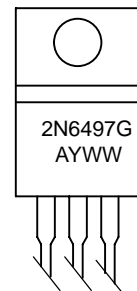
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**5 AMPERE
POWER TRANSISTORS
NPN SILICON
250 VOLTS – 80 WATTS**

MARKING DIAGRAM



**TO–220AB
CASE 221A
STYLE 1**



2N6497 = Device Code
G = Pb–Free Package
A = Assembly Location
Y = Year
WW = Work Week

ORDERING INFORMATION

| Device | Package | Shipping |
|---------|-----------------------|-----------------|
| 2N6497 | TO–220AB | 50 Units / Rail |
| 2N6497G | TO–220AB (Pb–Free) | 50 Units / Rail |

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

2N6497

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted) (Note 2)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|--|---------------|-----------|--------|------------|---------------|
| OFF CHARACTERISTICS | | | | | |
| Collector–Emitter Sustaining Voltage (Note 3) ($I_C = 25\text{ mAdc}$, $I_B = 0$) | $V_{CE(sus)}$ | 250 | – | – | Vdc |
| Collector Cutoff Current ($V_{CE} = 350\text{ Vdc}$, $V_{BE(off)} = 1.5\text{ Vdc}$) ($V_{CE} = 175\text{ Vdc}$, $V_{BE(off)} = 1.5\text{ Vdc}$, $T_C = 100^\circ\text{C}$) | I_{CEX} | – | – | 1.0 10 | mAdc |
| Emitter Cutoff Current ($V_{BE} = 6.0\text{ Vdc}$, $I_C = 0$) | I_{EBO} | – | – | 1.0 | mAdc |
| ON CHARACTERISTICS (Note 3) | | | | | |
| DC Current Gain ($I_C = 2.5\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$) ($I_C = 5.0\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$) | h_{FE} | 10 3.0 | – – | 75 – | – |
| Collector–Emitter Saturation Voltage ($I_C = 2.5\text{ Adc}$, $I_B = 500\text{ mAdc}$) ($I_C = 5.0\text{ Adc}$, $I_B = 2.0\text{ Adc}$) | $V_{CE(sat)}$ | – – | – – | 1.0 5.0 | Vdc |
| Base–Emitter Saturation Voltage ($I_C = 2.5\text{ Adc}$, $I_B = 500\text{ mAdc}$) ($I_C = 5.0\text{ Adc}$, $I_B = 2.0\text{ Adc}$) | $V_{BE(sat)}$ | – – | – – | 1.5 2.5 | Vdc |
| DYNAMIC CHARACTERISTICS | | | | | |
| Current–Gain – Bandwidth Product ($I_C = 250\text{ mAdc}$, $V_{CE} = 10\text{ Vdc}$, $f = 1.0\text{ MHz}$) | f_T | 5.0 | – | – | MHz |
| Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f = 100\text{ kHz}$) | C_{ob} | – | – | 150 | pF |
| SWITCHING CHARACTERISTICS | | | | | |
| Rise Time ($V_{CC} = 125\text{ Vdc}$, $I_C = 2.5\text{ Adc}$, $I_{B1} = 0.5\text{ Adc}$) | t_r | – | 0.4 | 1.0 | μs |
| Storage Time ($V_{CC} = 125\text{ Vdc}$, $I_C = 2.5\text{ Adc}$, $V_{BE} = 5.0\text{ Vdc}$, $I_{B1} = I_{B2} = 0.5\text{ Adc}$) | t_s | – | 1.4 | 2.5 | μs |
| Fall Time ($V_{CC} = 125\text{ Vdc}$, $I_C = 2.5\text{ Adc}$, $I_{B1} = I_{B2} = 0.5\text{ Adc}$) | t_f | – | 0.45 | 1.0 | μs |

2. Indicates JEDEC Registered Data.

3. Pulse Test: Pulse Width $\leq 300\ \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

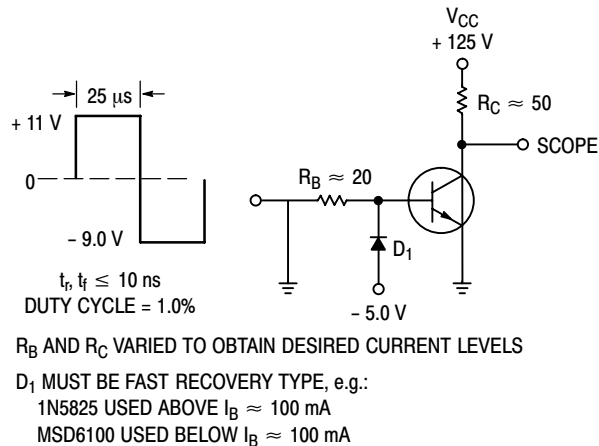


Figure 1. Switching Time Test Circuit

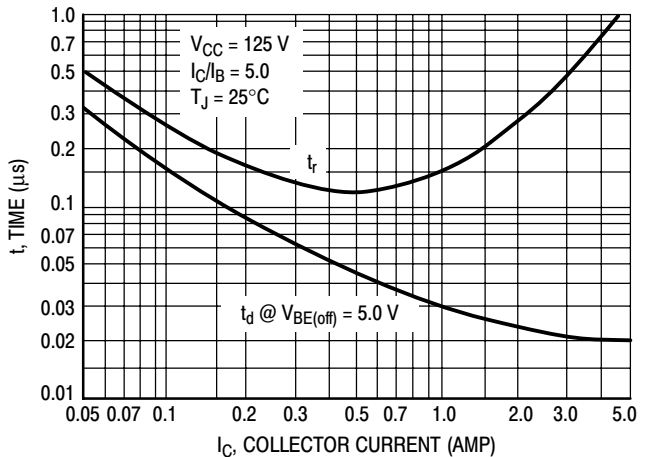


Figure 2. Turn–On Time

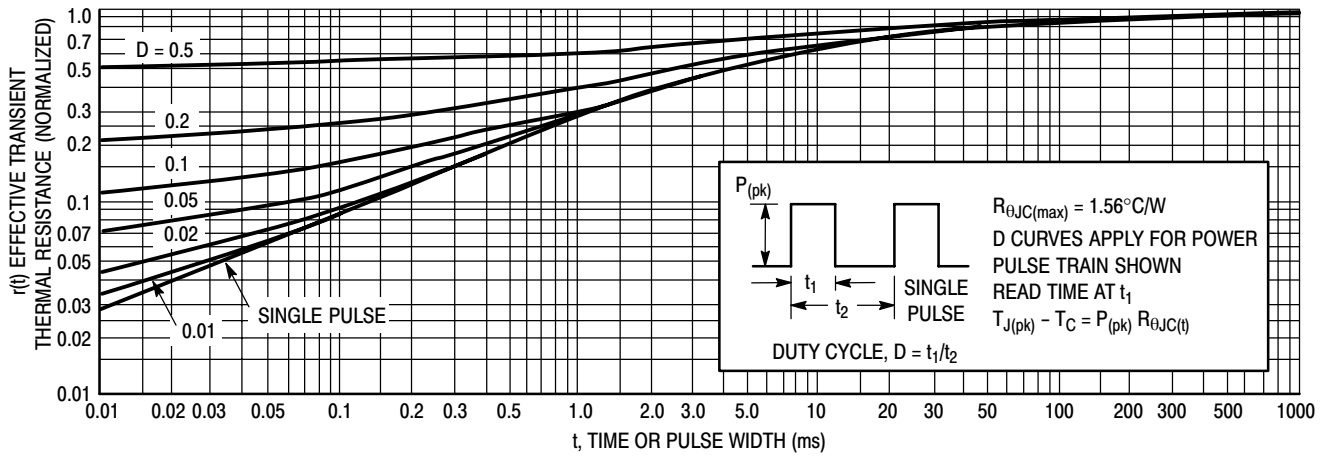


Figure 3. Thermal Response

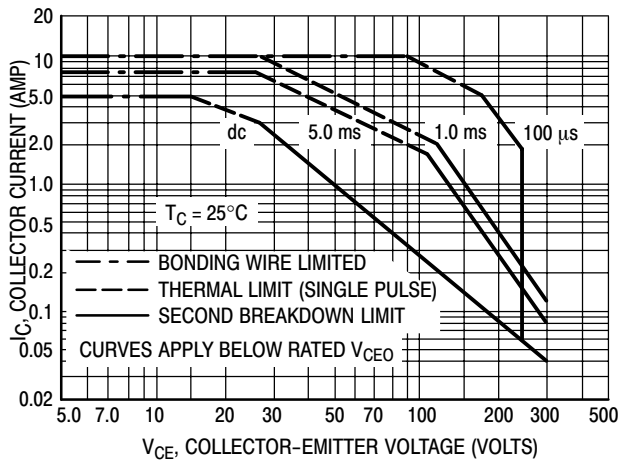


Figure 4. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 4 is based on $T_C = 25^\circ C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150^\circ C$. $T_{J(pk)}$ may be calculated from the data in Figure 3. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltage shown on Figure 4 may be found at any case temperature by using the appropriate curve on Figure 6.

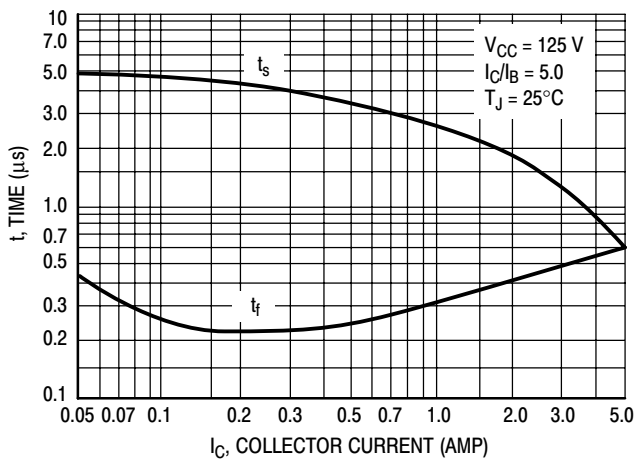


Figure 5. Turn-Off Time

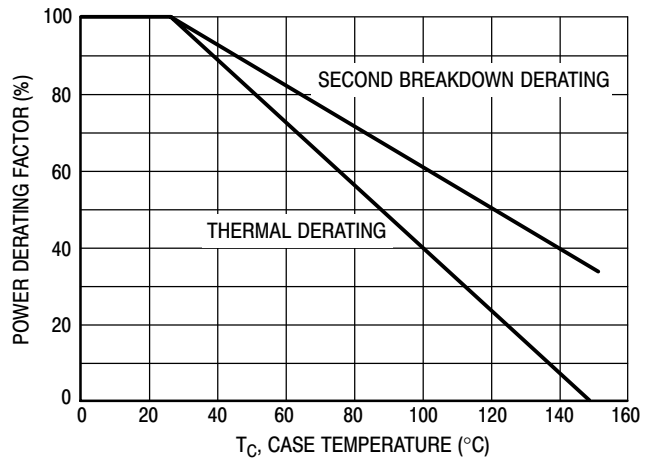


Figure 6. Power Derating

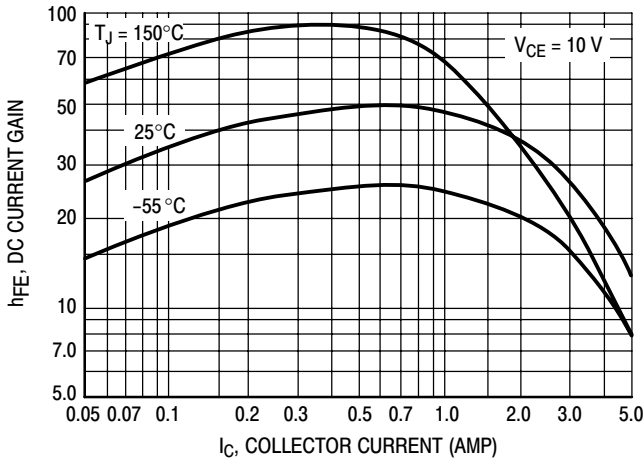


Figure 7. DC Current Gain

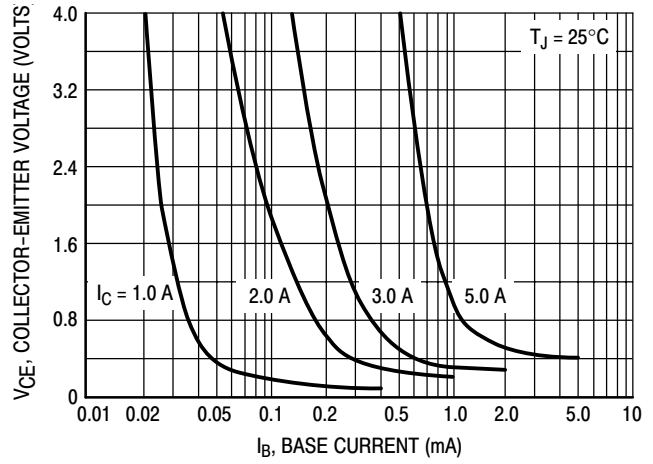


Figure 8. Collector Saturation Region

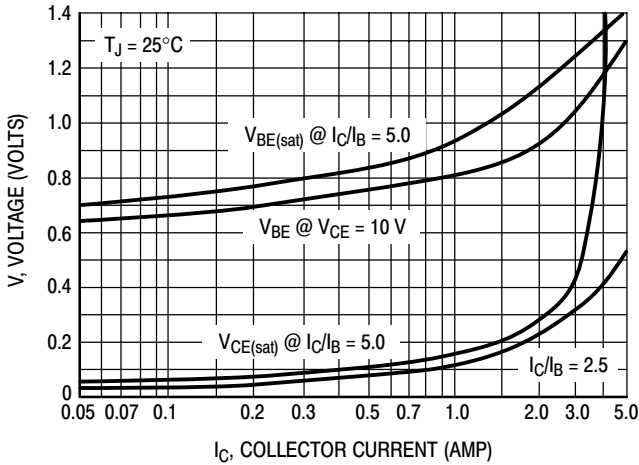


Figure 9. "On" Voltages

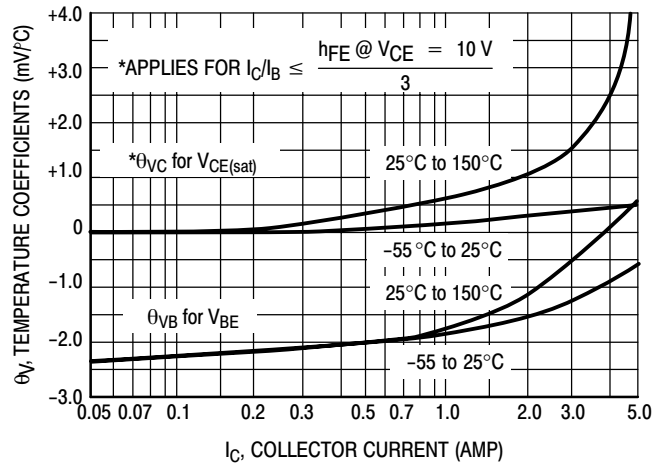


Figure 10. Temperature Coefficients

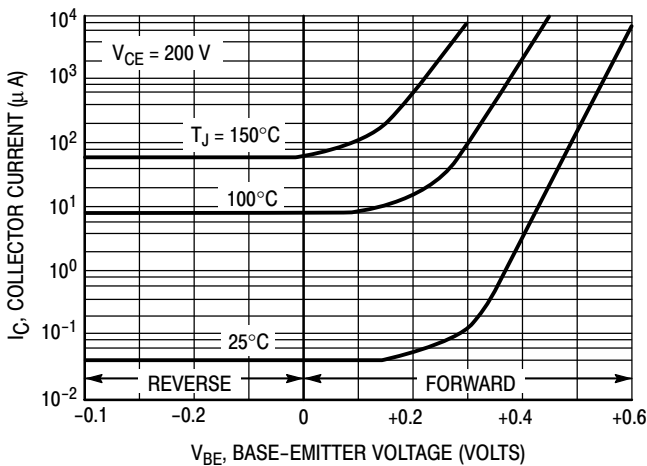


Figure 11. Collector Cutoff Region

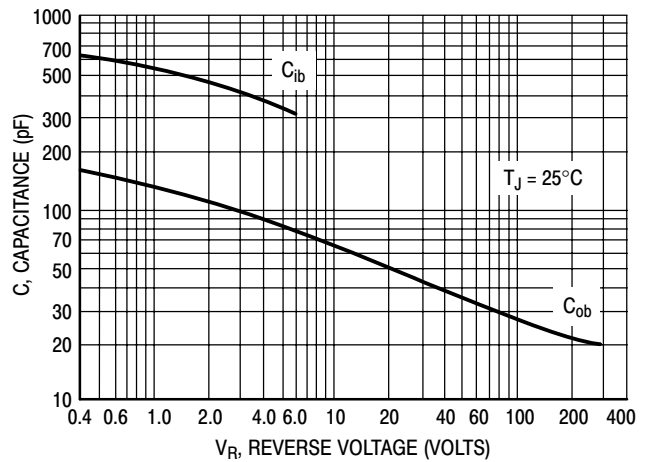


Figure 12. Capacitance

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